

NUM 2/28/00

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PATENT

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101280592

Submission Type

- New
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- Correction of PTO Error
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- Assignment
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- Security Agreement
- Change of Name
- Other:



Conveying Party(ies)

1. Raymond Wai Hang Chu
- 2.
- 3.
- 4.
- 5.
- 6.

Execution Date(s)

February 15, 2000

Mark if Additional Names of Conveying Parties Attached

Receiving Party

Name Defond Manufacturing Limited  
 Address 5th Floor, Chai Wan Industrial Centre  
 Address 20 Lee Chung Street  
 Address Chai Wan HONG KONG  
 City State/Country

Zip Code

Mark if Additional Names of Receiving Parties Attached

Correspondent Name and Address

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 Attorney Docket No. 400489/M&C

Pages Enter the total number of pages of the attached conveyance document including any attachments: 1

Application Number(s) or Patent Number(s)

Mark if additional numbers attached

Enter either the Patent Application Number or the Patent Number (DO NOT ENTER BOTH numbers for the same property).

Patent Application Numbers

Patent Numbers

09/469,366				

If this document is being filed together with a new Patent Application, enter the date the patent application was signed by the first named executing inventor. Month Day Year

Patent Cooperation Treaty (PCT)

Enter PCT application number only if a U.S. Application Number has not been assigned.

PCT	PCT	PCT
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Number of Properties

Enter the total number of properties involved: 1

Fee Amount

Fee Amount for Properties Listed (37 CFR 3.41): \$40.00

Method of Payment:

- Enclosed is a check in the amount of \$930.00
- Charge Deposit Account No. 12-1216

Authorization to Charge Additional Fees to Deposit Account No. 12-1216:  Yes  No

Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Charges to deposit account are authorized, as indicated herein.

Jeffrey A. Wyand

Name of Person Signing

Signature

February 28, 2000

Date

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PATENT  
REEL: 010573 FRAME: 0621

U.S. PATENT APPLICATION ASSIGNMENT  
SOLE OR JOINT INVENTORS  
EXECUTED OUTSIDE U.S.A.

Attorney's  
Docket No.: \_\_\_\_\_

WHEREAS, I (We), RAYMOND WAI HANG CHU, of 5th Floor, Chai Wan  
Industrial Centre, 20 Lee Chung Street, Chai Wan, Hong Kong,

as assignor(s), have invented certain improvements in  
POWER PLUG WITH CIRCUIT BREAKER

for which an application for United States Letters Patent  
has been executed by me (us) of even date herewith  
and whereas

DEFOND MANUFACTURING LIMITED, of 5th Floor, Chai Wan Industrial Centre, 20  
Lee Chung Street, Chai Wan, Hong Kong,

as assignee, is desirous of acquiring all right, title and in-  
terest for the United States in and to said invention and any  
U.S. Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00)  
and other good and valuable consideration, the receipt of which  
is hereby acknowledged, I (We), as assignor(s), hereby sell,  
assign and set over to said assignee the entire right, title and  
interest for the United States in and to said invention and the  
aforesaid United States application for Patent, all original,  
divisional, continuation, substitute or reissue applications and  
patents applied for or granted therefor in the United States in-  
cluding all rights of priority from the filing of said applica-  
tion, and the Commissioner of Patents is hereby authorized and  
requested to issue all patents on said invention or resulting  
therefrom to said assignee herein, as assignee of the entire  
interest therein; and the undersigned for myself (ourselves) and  
my (our) legal representatives, heirs and assigns do hereby agree  
and covenant without further remuneration, to execute and deliver  
all divisional, continuation, reissue and other applications for  
Patent on said invention and all assignments thereof to said  
assignee or its assigns, to communicate to said assignee or its  
representatives all facts known to the undersigned respecting  
said invention, whenever requested, to testify in any interfer-  
ences or other legal proceedings in which any of said applica-  
tions or patents may become involved, to sign all lawful papers,  
make all rightful oaths, and to do generally everything necessary  
to aid said assignee, its successors, assigns and nominees to  
obtain patent protection for said invention in the United States,  
the expenses incident to said applications to be borne and paid  
by said assignee.

Dated: 15 Feb 2000      Assignor : RAYMOND WAI HANG CHU  
Witnesses: (1) Chen Yuen  
(2) ADA ADA

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